

SEP 12 2005

Certificate of Facsimile Transmission

I hereby certify that the attached Transmittal (1 page), Response to the Office Action dated June 14, 2005 (7 pages), PTO form 2038 authorizing credit card payment of \$200.00 for additional claim fee are submitted to the U.S. Patent and Trademark Office via facsimile number 571-273-8300 on the date shown below. (Total 9 pages).


 Li Mei Vermilya

Date: September 12, 2005

 PATENT APPLICATION
 Attorney Docket No. 9903-071
 Client Ref. No. S02US035

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Jin-Hyuk LEE, et al.

Serial No.: 10/690,782

Examiner: Graybill, David E.

Filed: October 21, 2003

Group Art Unit: 2822

Confirmation No.: 5611

 For: METHOD FOR MANUFACTURING A WAFER LEVEL CHIP
 SCALE PACKAGE

 MAIL STOP AMENDMENT
 Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

Responsive to the Final Office Action dated June 14, 2005, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.


CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	19	17	0	x \$50 =	\$0
Independent Claims	4	3	1	x \$200 =	\$200
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$200

*greater of twenty (20) or number for which fee has been paid
 **greater of three (3) or number for which fee has been paid

- ☒ PTO Form 2038 authorizing credit card payment for the above-listed fees is enclosed.
☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

 Respectfully submitted,
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AMENDMENT

Responsive to the Office Action, Paper No. 20050608, dated June 14, 2005, please
amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on
page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.

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